



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Larry D. Kinsman

Serial No.: 10/792,229

Filed: March 3, 2004

For: BUMPED DIE AND WIRE BONDED
BOARD-ON-CHIP PACKAGE

Confirmation No.: 4782

Examiner: T. Ho

Group Art Unit: 2818

Attorney Docket No.: 2269-4585.3US
(00-0658.03/US)

Notice of Allowance Mailed:

May 8, 2006

NOTICE OF EXPRESS MAILING

Express Mail Mailing Label Number: EV 827473173 US

Date of Deposit with USPS: August 3, 2006

Person making Deposit: Brett Hooke

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 2 of this paper;

A listing of the claims begins on page 4 of this paper;

Remarks start at page 13 of this paper.